

NC7WBD3125

2-Bit Low Power Bus Switch with Level Shifting

General Description

The NC7WBD3125 is a 2-bit ultra high-speed CMOS FET bus switch with enhanced level shifting circuitry and with TTL-compatible active LOW control inputs. The low On Resistance of the switch allows inputs to be connected to outputs with minimal propagation delay and without generating additional ground bounce noise. The device is organized as a 2-bit switch with independent bus enable (\overline{OE}) controls. When \overline{OE} is LOW, the switch is ON and Port A is connected to Port B. When \overline{OE} is HIGH, the switch is OPEN and a high-impedance state exists between the two ports. Reduced voltage drive to the gate of the FET switch permits nominal level shifting of 5V to 3V through the switch. Control inputs tolerate voltages up to 5.5V independent of V_{CC} .

Features

- Space saving US8 surface mount package
- MicroPak™ Pb-Free leadless package
- Typical 3Ω switch resistance at 5.0V V_{CC} , $V_{IN} = 0V$
- Level shift facilitates 5V to 3.3V interfacing
- Minimal propagation delay through the switch
- Power down high impedance input/output
- Zero bounce in flow through mode
- TTL compatible active LOW control inputs
- Control inputs are overvoltage tolerant
- Bus switch replacement for x125 logic part

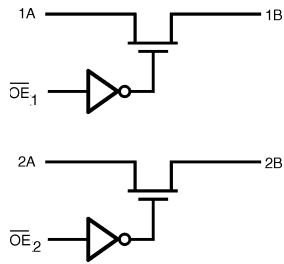
Ordering Code:

| Order Number | Package Number | Package Code Top Mark | Package Description | Supplied As |
|--------------------------------|----------------|-----------------------|---|---------------------------|
| NC7WBD3125K8X | MAB08A | WB5D | 8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide | 3k Units on Tape and Reel |
| NC7WBD3125L8X (Preliminary) | MAC08A | T9 | Pb-Free 8-Lead MicroPak, 1.6 mm Wide | 5k Units on Tape and Reel |

Pb-Free package per JEDEC J-STD-020B.

MicroPak™ is a trademark of Fairchild Semiconductor Corporation.

Logic Diagram



Pin Descriptions

| Pin Name | Description |
|----------|------------------|
| A | Bus A Switch I/O |
| B | Bus B Switch I/O |
| OE | Bus Enable Input |

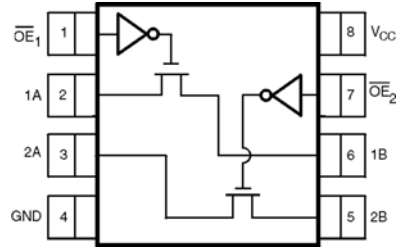
Function Table

| Bus Enable Input (OE) | Function |
|-----------------------|------------------|
| L | B Connected to A |
| H | Disconnected |

H = HIGH Logic Level
L = LOW Logic Level

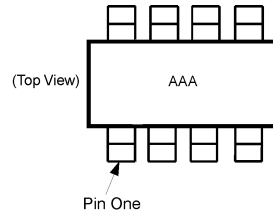
Connection Diagrams

Pin Assignments for US8



(Top View)

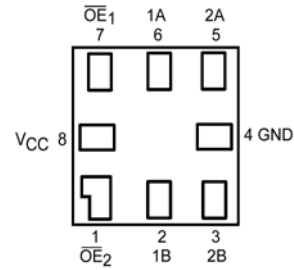
Pin One Orientation Diagram



AAA represents Product Code Top Mark - see ordering code

Note: Orientation of Top Mark determines Pin One location. Read the top product code mark left to right, Pin One is the lower left pin (see diagram).

Pad Assignments for MicroPak



(Top Through View)

Absolute Maximum Ratings (Note 1)

| | |
|---|-----------------|
| Supply Voltage (V_{CC}) | -0.5V to +7.0V |
| DC Switch Voltage (V_S) | -0.5V to +7.0V |
| DC Output Voltage (V_{IN}) (Note 2) | -0.5V to +7.0V |
| DC Input Diode Current | |
| (I_{IK}) $V_{IN} < 0V$ | -50 mA |
| DC Output (I_{OUT}) Current | 128 mA |
| DC V_{CC} or Ground Current | |
| (I_{CC}/I_{GND}) | ±100 mA |
| Storage Temperature Range (T_{STG}) | -65°C to +150°C |
| Junction Temperature under Bias (T_J) | +150°C |
| Lead Temperature (T_L) | |
| (Soldering, 10 Seconds) | +260°C |
| Power Dissipation (P_D) @ +85°C | 250 mW |

Recommended Operating Conditions (Note 3)

| | |
|---|------------------|
| Supply Operating (V_{CC}) | 4.5V to 5.5V |
| Control Input Voltage (V_{IN}) | 0V to 5.5V |
| Switch Input Voltage (V_{IN}) | 0V to 5.5V |
| Switch Output Voltage (V_{OUT}) | 0V to 5.5V |
| Operating Temperature (T_A) | -40°C to +85°C |
| Input Rise and Fall Time (t_r, t_f) | |
| Control Input | 0 ns/V to 5 ns/V |
| Switch I/O | 0 ns/V to DC |
| Thermal Resistance (θ_{JA}) | 250°C/W |

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

Note 3: Unused logic inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

| Symbol | Parameter | V_{CC} (V) | $T_A = -40^\circ\text{C to } +85^\circ\text{C}$ | | | Units | Conditions |
|-----------------|--|-----------------|---|------|------|-------|---|
| | | | Min | Typ | Max | | |
| V_{IK} | Clamp Diode Voltage | 4.5 | | | -1.2 | V | $I_{IN} = -18\text{ mA}$ |
| V_{IH} | HIGH Level Input Voltage | 4.5 to 5.5 | 2.0 | | | V | |
| V_{IL} | LOW Level Input Voltage | 4.5 to 5.5 | | | 0.8 | V | |
| V_{OH} | HIGH Level Output Voltage | 4.5 to 5.5 | See Figure 3 | | | V | $V_{IN} = V_{CC}$ |
| I_{IN} | Input Leakage Current | 5.5 | | | ±1.0 | µA | $0 \leq V_{IN} \leq 5.5V$ |
| I_{OFF} | Power OFF Leakage Current | 5.5 | | | ±1.0 | µA | $0 \leq A, B \leq V_{CC}$ |
| R_{ON} | Switch On Resistance (Note 4) | 4.5 | | 3.0 | 7.0 | Ω | $V_{IN} = 0V, I_{IN} = 64\text{ mA}$ |
| | | 4.5 | | 3.0 | 7.0 | | $V_{IN} = 0V, I_{IN} = 30\text{ mA}$ |
| | | 4.5 | | 15.0 | 50.0 | | $V_{IN} = 2.4V, I_{IN} = 15\text{ mA}$ |
| I_{CC} | Quiescent Supply Current | 5.5 | | 1.1 | 1.5 | mA | $V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$ |
| | | | | | | | 10.0 |
| ΔI_{CC} | Increase in I_{CC} per Input (Note 5) | 5.5 | | 1.0 | 2.5 | mA | $V_{IN} = 3.4V$, One \overline{OE} Input only, Other $\overline{OE} = V_{CC}$ |

Note 4: Measured by the voltage drop between A and B pins at the indicated current through the switch. On Resistance is determined by the lower of the voltages on the two (A or B) pins.

Note 5: Per TTL driven input ($V_{IN} = 3.4V$, control input only). A and B pins do not contribute to I_{CC} .

AC Electrical Characteristics

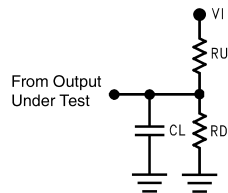
| Symbol | Parameter | V _{CC} (V) | T _A = -40°C to +85°C, C _L = 50 pF, R _U = R _D = 500Ω | | | Units | Conditions | Figure Number |
|--|--|------------------------|--|------|-----|-------|--|------------------|
| | | | Min | Typ | Max | | | |
| t _{PHL} , t _{PLH} | Propagation Delay Bus-to-Bus (Note 6) | 4.5 to 5.5 | | 0.25 | | ns | V _I = OPEN | Figures 1, 2 |
| t _{PZL} , t _{PZH} | Output Enable Time | 4.5 to 5.5 | 1.0 | 3.5 | 5.8 | ns | V _I = 7V for t _{PZL} V _I = 0V for t _{PZH} | Figures 1, 2 |
| t _{PLZ} , t _{PHZ} | Output Disable Time | 4.5 to 5.5 | 0.8 | 3.0 | 4.8 | ns | V _I = 7V for t _{PLZ} V _I = 0V for t _{PHZ} | Figures 1, 2 |

Note 6: This parameter is guaranteed. The bus switch contributes no propagation delay other than the RC delay of the typical On Resistance of the switch and the 50 pF load capacitance, when driven by an ideal voltage source (zero output impedance). The specified limit is calculated on this basis.

Capacitance

| Symbol | Parameter | Typ | Max | Units | Conditions |
|------------------------|-------------------------------|------|-----|-------|--|
| C _{IN} | Control Pin Input Capacitance | 2.5 | | pF | V _{CC} = 0V |
| C _{I/O} (OFF) | Port OFF Capacitance | 6.0 | | pF | V _{CC} = 5.0V = \overline{OE} |
| C _{I/O} (ON) | Port ON Capacitance | 12.0 | | pF | V _{CC} = 5.0V, \overline{OE} = 0V |

AC Loading and Waveforms



Input driven by 50Ω source terminated in 50Ω

C_L includes load and stray capacitance

Input PRR = 1.0 MHz; t_W = 500 ns

FIGURE 1. AC Test Circuit

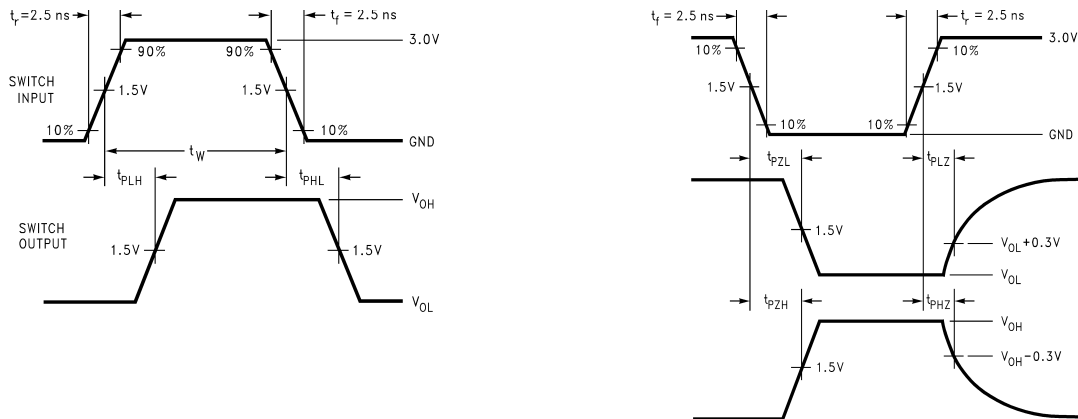


FIGURE 2. AC Waveforms

DC Electrical Characteristics

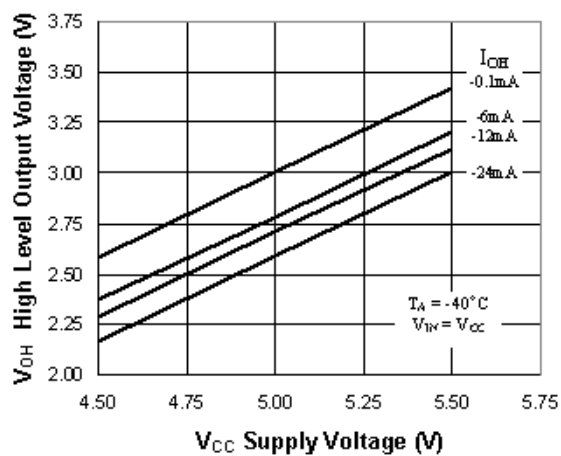
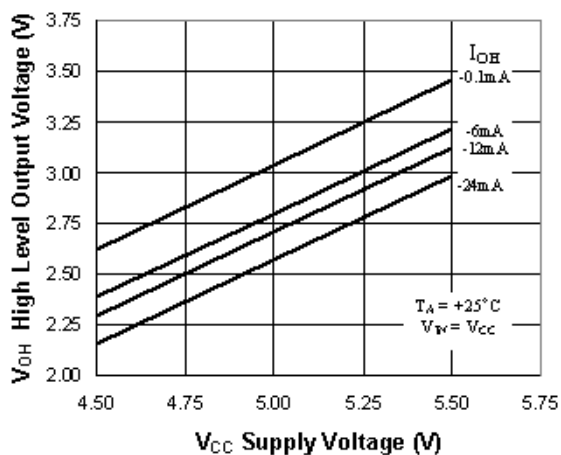
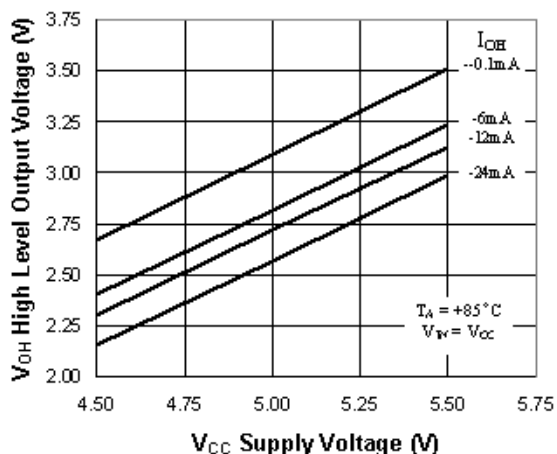


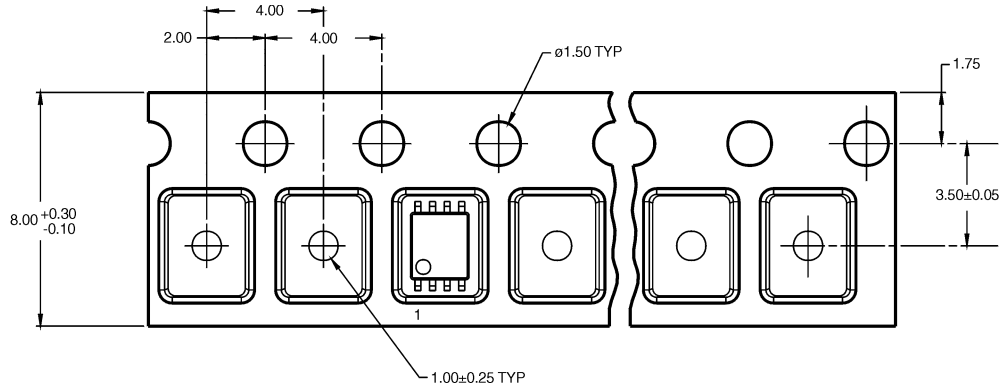
FIGURE 3. Typical High Level Output Voltage vs. Supply Voltage

Tape and Reel Specification

TAPE FORMAT for US8

| Package Designator | Tape Section | Number Cavities | Cavity Status | Cover Tape Status |
|--------------------|--------------------|-----------------|---------------|-------------------|
| K8X | Leader (Start End) | 125 (typ) | Empty | Sealed |
| | Carrier | 250 | Filled | Sealed |
| | Trailer (Hub End) | 75 (typ) | Empty | Sealed |

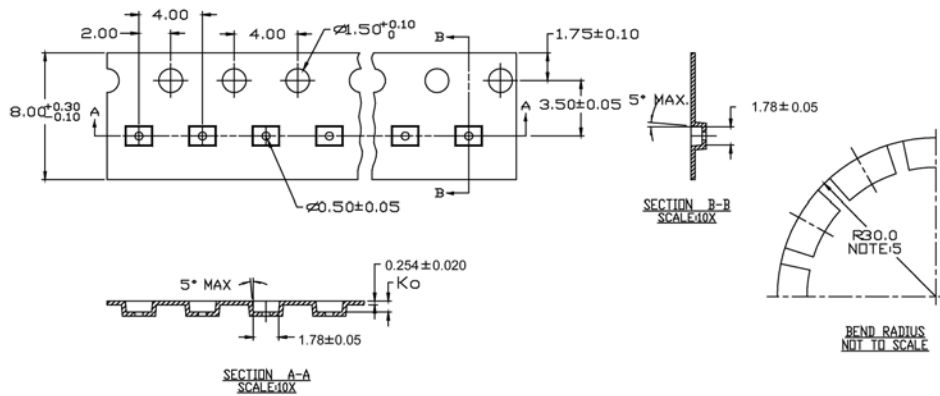
TAPE DIMENSIONS inches (millimeters)



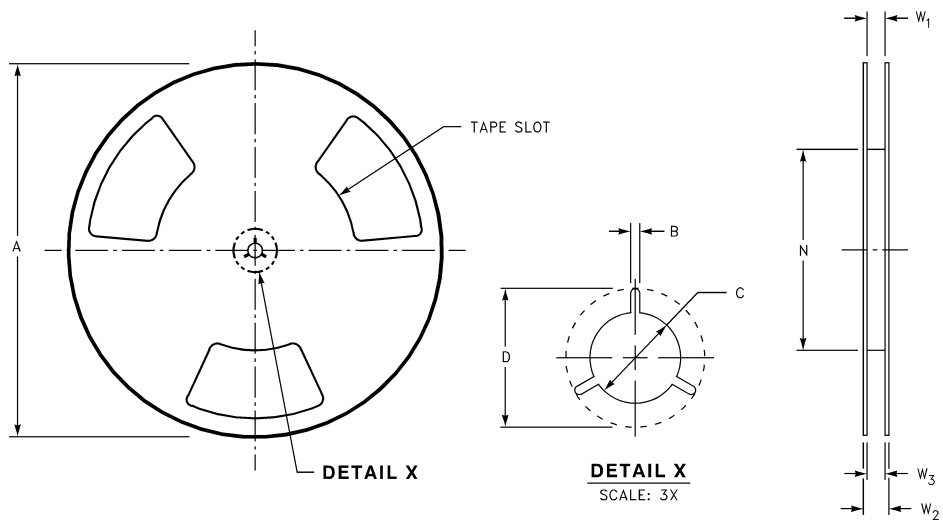
TAPE FORMAT for MicroPak

| Package Designator | Tape Section | Number Cavities | Cavity Status | Cover Tape Status |
|--------------------|--------------------|-----------------|---------------|-------------------|
| L8X | Leader (Start End) | 125 (typ) | Empty | Sealed |
| | Carrier | 250 | Filled | Sealed |
| | Trailer (Hub End) | 75 (typ) | Empty | Sealed |

TAPE DIMENSIONS inches (millimeters)

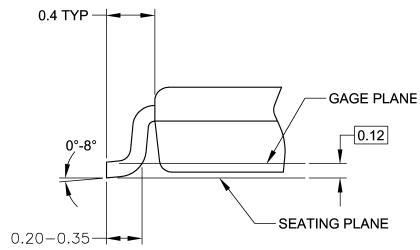
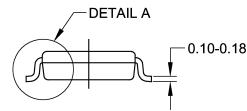
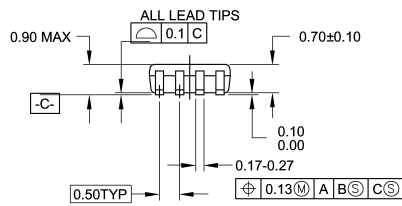
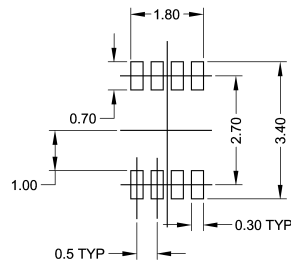
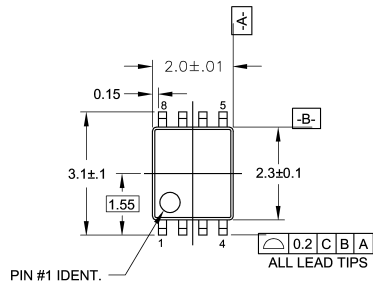


REEL DIMENSIONS inches (millimeters)



| Tape Size | A | B | C | D | N | W1 | W2 | W3 |
|-----------|----------------|-----------------|------------------|------------------|------------------|---|------------------|--|
| 8 mm | 7.0 (177.8) | 0.059 (1.50) | 0.512 (13.00) | 0.795 (20.20) | 2.165 (55.00) | 0.331 + 0.059/-0.000 (8.40 + 1.50/-0.00) | 0.567 (14.40) | W1 + 0.078/-0.039 (W1 + 2.00/-1.00) |

Physical Dimensions inches (millimeters) unless otherwise noted



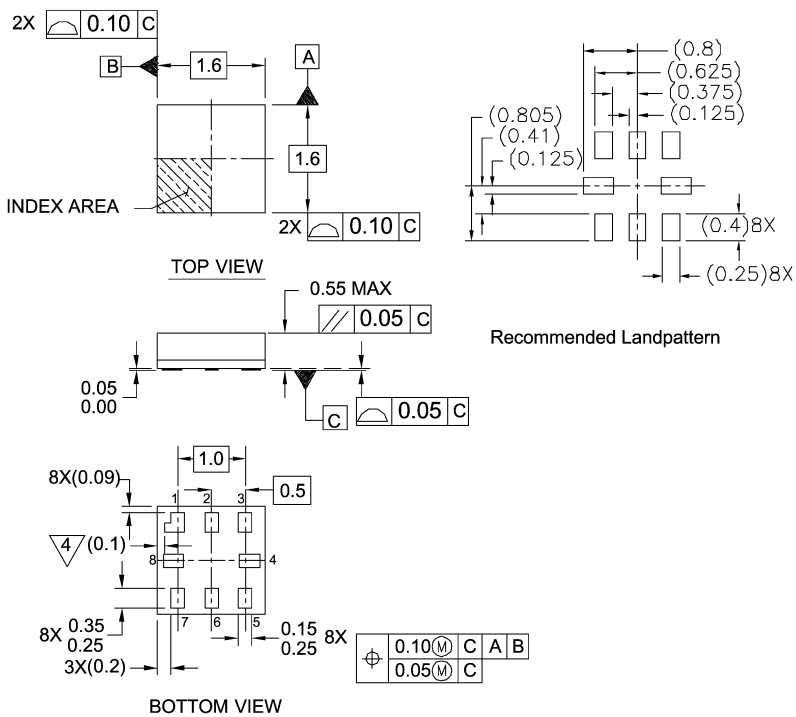
NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-187
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

MAB08AREVC

**8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide
Package Number MAB08A**

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Notes:

1. PACKAGE CONFORMS TO JEDEC MO-255 VARIATION UAAD
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y.14M-1994
4. PIN 1 FLAG, END OF PACKAGE OFFSET.

MAC08AREVC

**Pb-Free 8-Lead MicroPak, 1.6 mm Wide
Package Number MAC08A**

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| Datasheet Identification | Product Status | Definition |
|--------------------------|------------------------|---|
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